

# JW5392H/JW5392HF

18V/2A

Sync. Step-Down Converter

Preliminary Specifications Subject to Change without Notice

#### **DESCRIPTION**

The JW5392H and JW5392HF are monolithic buck switching regulators based on I2 architecture for fast transient response. Operating with an input range of 4.5V~18V, JW5392H and JW5392HF deliver 2A of continuous output current with two integrated N-Channel MOSFETs. The internal synchronous power switches provide high efficiency without the use of an external Schottky diode. At light loads, JW5392H operates in low frequency to maintain high efficiency.

JW5392H and JW5392HF guarantee robustness with output short protection, thermal protection, current run-away protection and input under voltage lockout.

JW5392H and JW5392HF are available in SOT563 package, which provide a compact solution with minimal external components.

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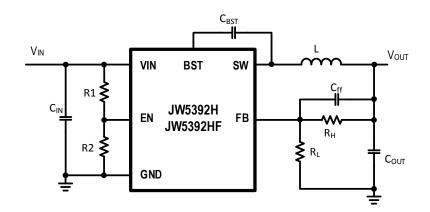
#### **FEATURES**

- 4.5V to 18V Operating Input Range 2A Output Current
- Up to 95% Efficiency
- PFM Mode (JW5392H) at Light Load
- FCC Mode (JW5392HF) at Light Load
- 1.2MHz Switching Frequency
- Internal Soft-start
- Input Under Voltage Lockout
- Current Run-away Protection
- Output Short Protection
- Thermal Protection
- Available in SOT563 Package

#### **APPLICATIONS**

- Distributed Power Systems
- Networking Systems
- FPGA, DSP, ASIC Power Supplies
- Green Electronics/ Appliances
- Notebook Computers

### TYPICAL APPLICATION



# **ORDER INFORMATION**

DEVICE <sup>1)</sup>	PACKAGE	TOP MARKING <sup>2)</sup>	ENVIRONMENTAL <sup>3)</sup>	
JW5392HSOTI#TR	SOT563	JWh□	Green	
JWJ3392113O11#1N	301303	YW□□	Green	
JW5392HFSOTI#TR	SOT563	JAW□	Green	
1447225511L2O11#1V	301303	YW□□	3.2011	

#### Notes:

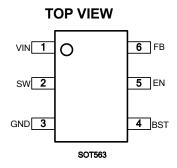


3) All Joulwatt products are packaged with Pb-free and Halogen-free materials and compliant to RoHS standards.

# **DEVICE INFORMATION**

DEVICE	Operation Mode at light load	Function	Package
JW5392HSOTI#TR	PFM	-	SOT563
JW5392HFSOTI#TR	FCCM	-	SOT563

# **PIN CONFIGURATION**



# **ABSOLUTE MAXIMUM RATING**1)

VIN, EN Pin  SW Pin  BST Pin  All other Pins  Junction Temperature <sup>2)</sup>	0.3V(-5V for 10ns) to 20V(22V fo SW-0.3V to SW+4V (+4.8V for 10.3)	or 10ns) for 10ns) .3V to 4V
Lead Temperature  Storage Temperature  RECOMMENDED OPERATING CONDITIONS	65°C to	260°C
Input Voltage V <sub>IN</sub> Output Voltage V <sub>OUT</sub> Operating Junction Temperature	0.8V to \	√ <sub>IN</sub> *Dmax
THERMAL PERFORMANCE <sup>4)</sup>	$oldsymbol{ heta_{\!\scriptscriptstyle M}}$	$ heta_{Jc}$
SOT563	145	45°C/W

#### Note:

- 1) Exceeding these ratings may damage the device. These stress ratings do not imply function operation of the device at any other conditions beyond those indicated under RECOMMENDED OPERATING CONDITIONS.
- 2) The JW5392H and JW5392HF include thermal protection that is intended to protect the device in overload conditions. Continuous operation over the specified absolute maximum operating junction temperature may damage the device.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

# **ELECTRICAL CHARACTERISTICS**

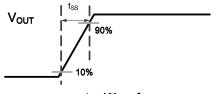
V<sub>IN</sub>=12V, T<sub>J</sub>=25°C, unless otherwise stated.

Advance Information, not production data, subject to change without notice.

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
V <sub>IN</sub> Under Voltage Lock-out Threshold	V <sub>IN_MIN</sub>	V <sub>IN</sub> rising	4.0	4.2	4.5	V
V <sub>IN</sub> Under Voltage Lock-out Hysteresis	VIN_MIN_HYST			350		mV
Shutdown Supply Current	I <sub>SD</sub>	V <sub>EN</sub> =0V			1	μA
Supply Current	IQ	V <sub>EN</sub> =5V, V <sub>FB</sub> =1.2V		150	220	μΑ
Feedback Voltage	V <sub>FB</sub>	4.5≤V <sub>VIN</sub> ≤18V	792	800	808	mV
reedback voltage	<b>V</b> FB	T <sub>j</sub> =-40 °C~125 °C	784	800	816	mV
FB Leakage Current	I <sub>FB</sub>	V <sub>FB</sub> =0.85V			100	nA
Top Switch Resistance	R <sub>DS(ON)T</sub>			95		mΩ
Bottom Switch Resistance	R <sub>DS(ON)B</sub>			55		mΩ
Top Switch Leakage Current	I <sub>LEAK_TOP</sub>	V <sub>IN</sub> =18V, V <sub>EN</sub> =0V, V <sub>SW</sub> =0V			1	μA
Bottom Switch Leakage Current	ILEAK_BOT	V <sub>IN</sub> =18, V <sub>EN</sub> =0V, V <sub>SW</sub> =18V			4	μΑ
Bottom Switch Current Limit	I <sub>LIM_BOT</sub>		2.2	2.7	3.2	Α
Negative Current Limit	ILIM_NEG	JW5392HF	-1.27	-1.5	-1.72	Α
Minimum On Time <sup>5)</sup>	Ton_min			100		ns
Minimum Off Time	Toff_MIN	V <sub>FB</sub> =0.4V		120		ns
Maximum On Time	T <sub>ON_Max</sub>			4		us
EN Rising Threshold	V <sub>EN_H</sub>	V <sub>EN</sub> rising	1.1	1.2	1.3	V
EN Falling Threshold	V <sub>EN_L</sub>	V <sub>EN</sub> falling	0.98	1.05	1.12	V
Switching Frequency	F <sub>SW</sub>			1200		kHz
Soft-Start Period <sup>5)6)</sup>	tss		1	1.4	2	ms
Thermal Shutdown <sup>5)</sup>	T <sub>TSD</sub>			160		°C
Thermal Shutdown Hysteresis <sup>5)</sup>	T <sub>TSD_HYST</sub>			20		°C

#### Note:

- 5) Guaranteed by design.
- 6) Soft-Start Period is tested from 10% to 90% of the steady state output voltage.

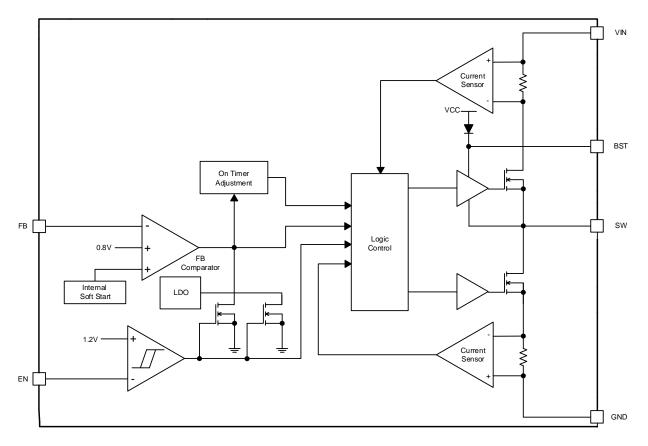


tss Waveform

# PIN DESCRIPTION

SOT563	Name	Description
	VIN	Input voltage pin. VIN supplies power to the IC. Connect a 4.5V to 18V supply to VIN and
1		bypass VIN to GND with a suitably large capacitor to eliminate noise on the input to the
		IC.
2	SW	SW is the switching node that supplies power to the output. Connect the output LC filter
2		from SW to the output load.
3	GND	Ground pin.
4	BST	Connect a 0.1µF capacitor between BST and SW pin to supply current for the top switch
4		driver.
5	EN	Drive EN pin high to turn on the regulator and low to turn off the regulator.
6	FB	Output feedback pin. FB senses the output voltage and is regulated by the control loop
0	I D	to 0.8 V. Connect a resistive divider at FB.

# **BLOCK DIAGRAM**



# **FUNCTIONAL DESCRIPTION**

JW5392H and JW5392HF are synchronous step-down regulators based on I2 control architecture. It regulates input voltages from 4.5V to 18V down to an output voltage as low as 0.8V, and is capable of supplying up to 2A of load current.

#### **Shut-Down Mode**

The regulator shuts down when voltage at EN pin is driven below 0.4V. The entire regulator is off and the supply current consumed by the regulator drops below  $1\mu$ A.

#### **Power Switch**

N-Channel MOSFET switches are integrated on the JW5392H and JW5392HF to down convert the input voltage to the regulated output voltage. Since the top MOSFET needs a gate voltage great than the input voltage, a boost capacitor connected between BST and SW pins is required to drive the gate of the top switch. The boost capacitor is charged by the internal 3.3V rail when SW is low.

#### **VIN Under-Voltage Protection**

A resistive divider can be connected between  $V_{\text{IN}}$  and ground, with the central tap connected to EN, so that when  $V_{\text{IN}}$  drops to the pre-set value, EN drops below 1.05V to trigger input under voltage lockout protection.

#### **Output Current Run-Away Protection**

At start-up, due to the high voltage at input and low voltage at output, current inertia of the output inductor can be easily built up, resulting in a large start-up output current. A valley current limit is designed in JW5392H and JW5392HF so that only when output current drops below the valley current limit can the top power switch be turned on. By such control mechanism, the output current at start-up is well controlled.

#### **Output Short Protection**

When the output is shorted to ground, the regulator is allowed to switch for 2048 cycles. If the short condition is cleared within this period, then the regulator resumes normal operation. If the short condition is still present after 2048 switching cycles, then no switching is allowed and the regulator enters hiccup mode for 6144 cycles. After the 6144 hiccup cycles, the regulator will try to start-up again. If the short condition still exists after 2048 cycles of switching, the regulator enters hiccup mode. This process of start-up and hiccup iterate itself until the short condition is removed.

#### **Thermal Protection**

When the temperature of the regulator rises above 160°C, it is forced into thermal shut-down. Only when core temperature drops below 140°C can the regulator become active again.

## **APPLICATION INFORMATION**

## **Output Voltage Set**

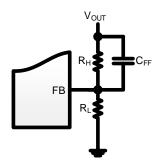
The output voltage is determined by the resistor divider connected at the FB pin, and the voltage ratio is:

$$V_{FB} = V_{OUT} * \frac{R_L}{R_H + R_L}$$

where  $V_{\text{FB}}$  is the feedback voltage and  $V_{\text{OUT}}$  is the output voltage.

If  $R_L$  is determined, and then  $R_H$  can be calculated by:

$$R_{\rm H} = R_{\rm L} * \left(\frac{V_{\rm OUT}}{0.8} - 1\right)$$



# **Feedforward Capacitor**

In order to ensure stability, a feedforward capacitor  $C_{\text{FF}}$  about dozens of picofarads is needed to be in parallel with  $R_{\text{H}}$ .

#### **Input Capacitor**

The input capacitor is used to supply the AC input current to the step-down converter and maintaining the DC input voltage. Estimate the RMS current in the input capacitor with:

$$I_{CIN} = I_{OUT} * \sqrt{\frac{V_{OUT}}{V_{IN}} * \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}$$

where  $I_{OUT}$  is the load current,  $V_{OUT}$  is the output voltage,  $V_{IN}$  is the input voltage.

Thus the input capacitor can be calculated by the following equation when the input ripple voltage is determined.

$$C_{IN} = \frac{I_{OUT}}{f_S * \Delta V_{IN}} * \frac{V_{OUT}}{V_{IN}} * \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

where  $C_{IN}$  is the input capacitance value,  $f_s$  is the switching frequency,  $\Delta V_{IN}$  is the input ripple voltage.

The input capacitor can be electrolytic, tantalum or ceramic. To minimizing the potential noise, a small X5R or X7R ceramic capacitor, i.e.  $0.1\mu F$ , should be placed as close to the IC as possible when using electrolytic capacitors.

A  $22\mu F/25V$  ceramic capacitor is recommended in typical application.

#### **Output Capacitor**

The output capacitor is required to maintain the DC output voltage, and the capacitance value determines the output ripple voltage. The output voltage ripple can be calculated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_S * L} * \left(1 - \frac{V_{OUT}}{V_{IN}}\right) * \left(R_{ESR} + \frac{1}{8 * f_S * C_{OUT}}\right)$$

where  $C_{\text{OUT}}$  is the output capacitance value and  $R_{\text{ESR}}$  is the equivalent series resistance value of the output capacitor.

The output capacitor can be low ESR electrolytic, tantalum or ceramic, which lower ESR capacitors get lower output ripple voltage. The output capacitors also affect the system stability and transient response, and a  $22\mu\text{F}\sim44\mu\text{F}$  ceramic capacitor is recommended in typical application.

#### Inductor

The inductor is used to supply constant current to the output load, and the value determines the ripple current which affect the efficiency and the output voltage ripple. The ripple current is typically allowed to be 40% of the maximum switch current limit, thus the inductance value can be calculated by:

$$L = \frac{V_{OUT}}{f_{S} * \Delta I_{L}} * \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

where  $V_{IN}$  is the input voltage,  $V_{OUT}$  is the output voltage,  $f_s$  is the switching frequency, and  $\Delta I_L$  is the peak-to-peak inductor ripple current.

#### **External Bootstrap Capacitor**

The bootstrap capacitor is required to supply voltage to the top switch driver. A  $0.1\mu F$  low ESR ceramic capacitor is recommended to connected to the BST pin and SW pin.

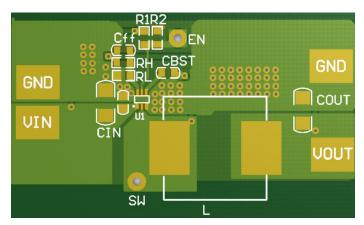
### **PCB Layout Note**

For minimum noise problem and best operating performance, the PCB is preferred to following the guidelines as reference.

1. Place the input decoupling capacitor as close to JW5392H/JW5392HF (VIN pin and

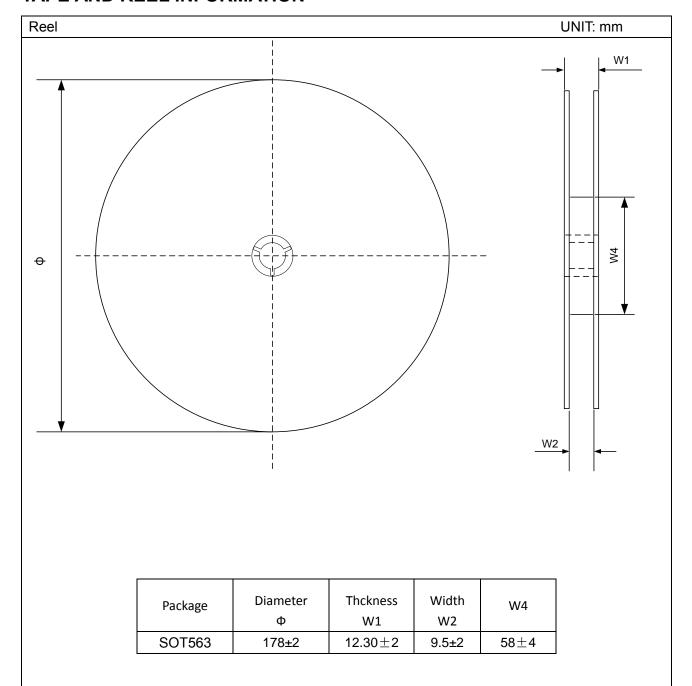
- GND pin) as possible to eliminate noise at the input pin. The loop area formed by input capacitor and GND must be minimized.
- Put the feedback trace as short as possible, and far away from the inductor and noisy power traces like SW node.
- 3. The ground plane on the PCB should be as large as possible for better heat dissipation.
- 4. Keep the switching node SW short to prevent excessive capacitive coupling
- Make V<sub>IN</sub>, V<sub>OUT</sub> and ground bus connections as wide as possible. This reduces any voltage drops on the input or output paths of the converter and maximizes efficiency.

#### SOT563:

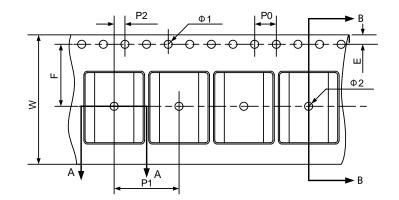


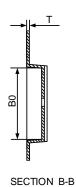
**PCB Layout Recommendation** 

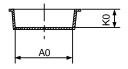
# TAPE AND REEL INFORMATION



**Carrier Tape** UNIT: mm







SECTION A-A

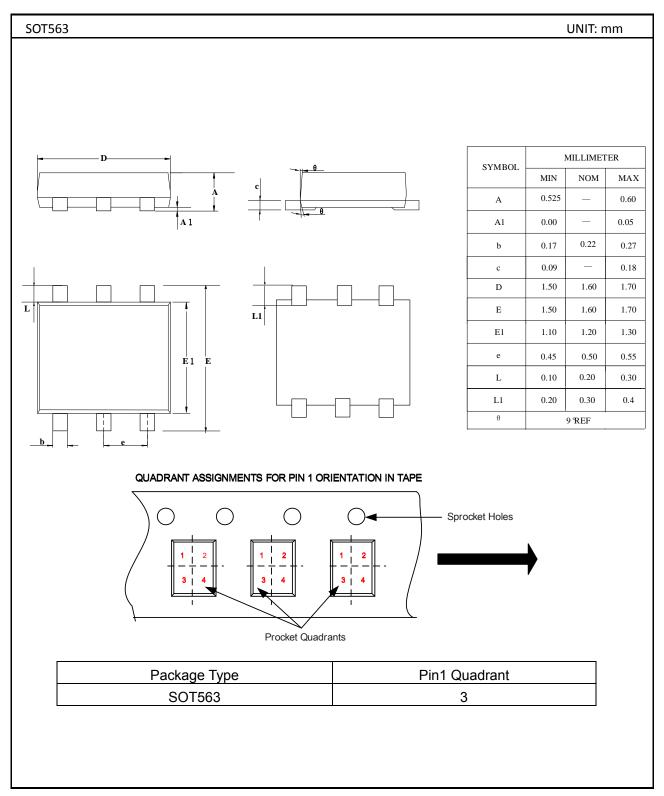
- Note:

  1) The carrier type is black, and colorless transparent.

  - 2) Carrier camber is within 1mm in 100mm.3) 10 pocket hole pitch cumulative tolerance:±0.20.
  - 4) All dimensions are in mm.

Doolsogo	Tape dimensions(mm)							m)				
Package	P0	P2	P1	A0	В0	W	Т	КО	Ф1	Ф2	Е	F
SOT563	4.0±0.1	2.0±0.1	4.0±0.1	1.78±0.3	1.78±0.3	8.0±0.3	0.20±0.2	0.69±0.2	1.50min	0.50±0.10	1.75±0.1	3.50±0.10

# **PACKAGE OUTLINE**



JW5392H/JW5392HF JoulWatt

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